MIP2K20MS

Silicon MOS FET type integrated circuit

■ Features

- Built-in jitter function
- Built-in charge protection circuit

 Built-in overheating, loadshorting and overvoltage protection circuits

■ Applications

- Chargers (for DSC, etc.)
- AC adapter

■ Absolute Maximum Ratings $T_a = 25$ °C±3°C

Parameter	Symbol	Rating	Unit	
DRAIN voltage	VD	- 0.3 to +700	V	
VCC voltage	VCC	- 0.3 to +45	V	
VDD voltage	VDD	- 0.3 to +8	V	
Feedback voltage	VFB	- 0.3 to +8	V	
Feedback current	IFB	500	μΑ	
CL pin voltage	VCL	- 0.3 to +8	V	
CL pin current	ICL	150	μΑ	
Output peak current *	IDP	0.95	A	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note) *: The guarantee within the following pulse width.

Leading edge blanking delay + Current limit delay ton(BLK) + td(OCL)

■ Package

Code

DIP7-A1

• Pin Name

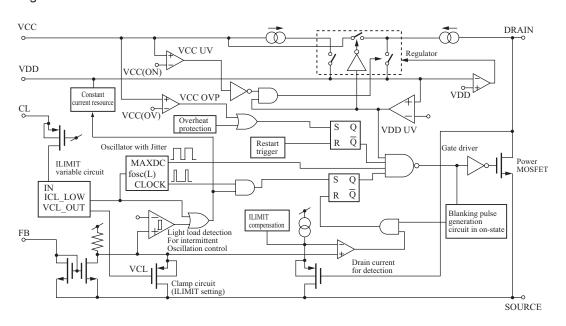
1. VDD 5. DRAIN 2. FB 6. —

3. CL 7. SOURCE

4. VCC 8. SOURCE

■ Marking Symbol: MIP2K2

■ Block Diagram



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■ Electrical Characteristics $T_C = 25$ °C±2°C

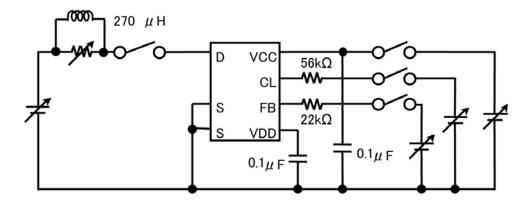
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Control functions			·			
Outside for account	fosc	VCC = 15 V, VD = 5 V, IFB = 20 μ A, ICL = 50 μ A	90	100	110	kHz
Output frequency	fosc(L)	VCC = 15 V, VD = 5 V, IFB: Open, ICL < ICL1	9	12	15	kHz
Jitter frequency deviation	Δf	VCC = 15 V, VD = 5 V, IFB = 20 μ A, ICL = 50 μ A		5.5		kHz
Jitter frequency modulation rate	fM	VCC = 15 V, VD = 5 V, IFB = 20 μ A, ICL = 50 μ A		260		Hz
Maximum duty cycle	MAXDC	VCC = 15 V, VD = 5 V, IFB = 20 μ A, ICL = 50 μ A	45	47.5	50	%
VDD voltage	VDD	VCC = 15 V, VD = 5 V, IFB = 20 μ A, ICL = 50 μ A	5.4	5.9	6.4	V
UV lockout threshold voltage	VUV	$VD = 5 \text{ V, IFB} = 20 \mu\text{A, ICL} = 50 \mu\text{A}$	4.6	5.1	5.6	V
VCC start voltage	VCC(ON)	$VD = 5 \text{ V, IFB} = 20 \mu\text{A, ICL} = 50 \mu\text{A}$	5.9	6.9	7.9	V
VCC charge stop threshold voltage	VCC1	VD = 40 V, FB: Open, CL: Open	11.8	12.8	13.8	V
Feedback threshold voltage	IFB1	ON \rightarrow OFF VCC = 15 V, VD = 5 V, ICL = 50 μ A	21	41	61	μА
Feedback hysteresis current	IFBHYS	VCC = 15 V, VD = 5 V, ICL = 50 μA		2		μА
FB pin current at heavy load	IFB0	ICC0 \rightarrow ICC VCC = 15 V, VD = 5 V, ICL = 50 μ A	6	9.5	13	μА
FB pin voltage	VFB	$VCC = 15 \text{ V}, \text{ VD} = 5 \text{ V}, \text{ IFB} = 20 \mu\text{A},$ $ICL = 50 \mu\text{A}$		1.0	1.3	V
Supply current	eurrent ICC $VCC = 15 \text{ V, VD} = 5 \text{ V, IFB} = 20 \mu\text{A},$ $ICL = 50 \mu\text{A}$		0.25	0.40	0.50	mA
Supply current at light load	ICC(OFF)	VCC = 15 V, VD = 5 V, IFB = IFB1 + 5 μ A, ICL = 50 μ A	0.26	0.36	0.46	mA
Supply current at heavy load	ICC0	VCC = 15 V, VD = 5 V, IFB: Open, ICL = 50 μ A	0.45	0.60	0.75	mA
VDD charging current	Ich1	VDD = 0 V, VD = 40 V, FB: Open, CL: Open	-5.8	-3.8	-1.8	mA
	Ich2	VDD = 4 V, VD = 40 V, FB: Open, CL: Open	-2.2	-1.3	-0.4	mA
CL pin voltage	VCL	VCC = 15 V, VD = 5 V, FB: Open, ICL = ICL1	2.0	2.3	2.6	V
Dropped fosc CL pin current *2	Dropped fosc CL pin current *2 ICL1 fosc - VCC		16.5	22	27.5	μА
CL pin hysteresis current *2	ICLHYS	VCC = 15 V, VD = 5 V, FB: Open		1.5		μΑ

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■ Electrical Characteristics (continued) $T_C = 25$ °C±2°C

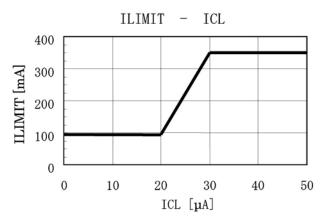
Parameter	Symbol Conditions		Min	Тур	Max	Unit
Circuit protections				•		
Self protection current limit *1, 3	ILIMIT	VCC = 15 V, FB: Open, ICL = 50 μA, DUTY = 30%	0.315	0.350	0.385	A
ILIMIT modified coefficient *1,3	R_slope	VCC = 15 V, FB: Open, ICL = 50 μA		28		mA/μs
Minimum ILIMIT	ILIMITmin	Ton = 3 μ s, VCC = 15 V, FB: Open, ICL = 0 μ A	FB: Open, 40		200	mA
Drain current at light load	ID(OFF)	Ton = 3 μ s, VCC = 15 V, IFB = IFB1 + IFBHYS, ICL = 50 μ A	30	70	150	mA
Leading edge blanking delay	ton(BLK)	VCC = 15 V, FB: Open, ICL = $50 \mu A$	230	290	350	ns
Current limit delay	td(OCL)		100	150	200	ns
Over voltage protection	VCC(OV)	VD = 5 V, FB: Open, ICL = 50 μA	22	24.5	27	V
Thermal shutdown temperature	TOTP		130	140	150	°C
Output	•					
Power up reset threshold voltage	VDDreset		1.8	2.6	3.5	V
ON state resistance	RDS(ON)	ID = 100 mA		16.5	21	Ω
OFF state current	IDSS	VCC = 26 V, VD = 650 V, FB: Open, CL: Open		10	20	μА
Breakdown voltage	VDSS	VCC = 26 V, ID = 100 μA, FB: Open, CL: Open	700			V
Rise time *4	tr	VCC = 15 V, VD = 5 V, FB: Open, ICL = 50 µA	10			ns
Fall time *4	tf	VCC = 15 V, VD = 5 V, FB: Open, ICL = 50 μA		25		ns
Supply voltage characteristics						
Drain supply voltage	VD(MIN)	VCC: Open, FB: Open, CL: Open	50			V

Note) 1. Measurement circuit

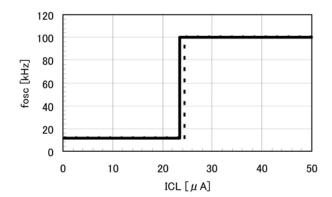


■ Electrical Characteristics (continued) $T_C = 25$ °C±2°C

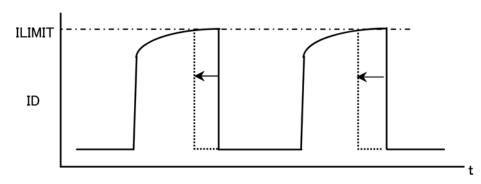
2. *1: ILIMIT vs. ICL Typical characteristic



*2: fosc vs. ICL Typical characteristic

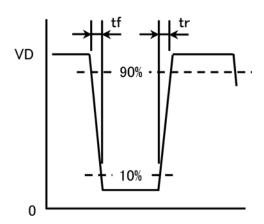


*3: ILIMIT Measurement



R_slope; {(ILIMIT at Duty=30%) - (ILIMIT at Duty=10%)} / {(Ton at Duty=30%) - (Ton at Duty=10%)]

*4: tr, tf Measurement

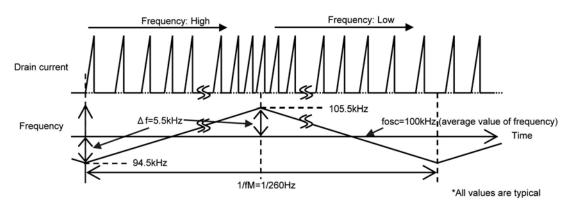


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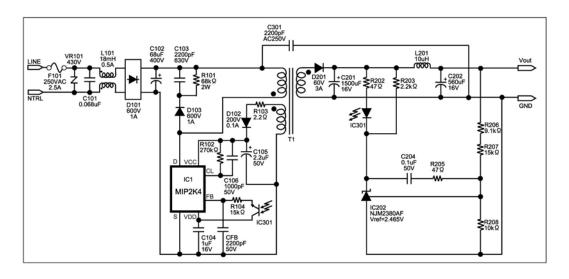
■ Frequency jitter function

By frequency jitter function, frequency jitter variation(Δf) changes periodically, by frequency of frequency jitter modulation factor (fM) as shown below.

 $fosc = 100 \text{ kHz (typ.)}, \Delta f = 5.5 \text{ kHz (typ.)}, fM = 260 \text{ Hz (typ.)}$



■ Adapter circuit sample (MIP2K4)



■ Electric characteristics (MIP2K4: Worldwide input, 8.3V/1.5A output)

VI characteristics of adapter circuit

Vo vs Io

Vo vs Io

S S 4

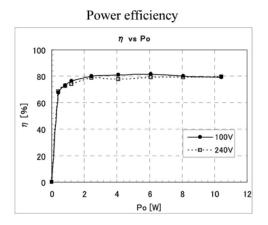
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2

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1 2 3



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MIP00** MIP55** MIP816/826	MIP52** MIP56** MIP9E**	MIP53** MIP803/804	· Japanese companies in Japan · Japanese companies in Asia (50% or more owned) · Asian companies in Asia	· Companies in European and American countries · Other local companies	· For power supply · For EL driver · For LED lighting driver
MIP50**	MIP51**	MIP7**	· No restrictions in terms of contract	· No restrictions in terms of contract	· For lamp driver/ car electronics accessories

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